

ABSTRACT

A holding structure for an electronic part includes a first resin mold which has a positioning shape portion for the electronic part, and a second resin mold which is insert-molded to cover the first resin mold and the electronic part positioned with the first resin mold. Through holes for passing an insert resin material adapted to form the second resin mold is formed in the positioning shape portion of the first resin mold. The holding structure for the electronic part improves the positioning accuracy of the electronic part by virtue of the positioning shape portion for accommodating the electronic part, and prevents occurrence of deformations and cracks in the positioning shape portion due to insert-molding.